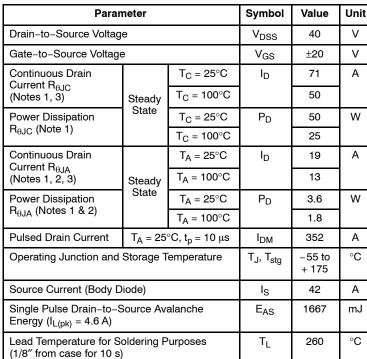
MOSFET - Power, Single N-Channel 40 V, 5.3 mΩ, 71 A

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- LFPAK4 Package, Industry Standard
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)



Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	3.0	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	40	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

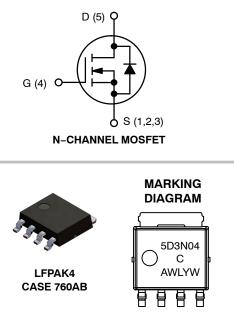
3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

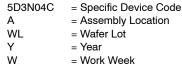


ON Semiconductor®

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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	5.3 m Ω @ 10 V	71 A





ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

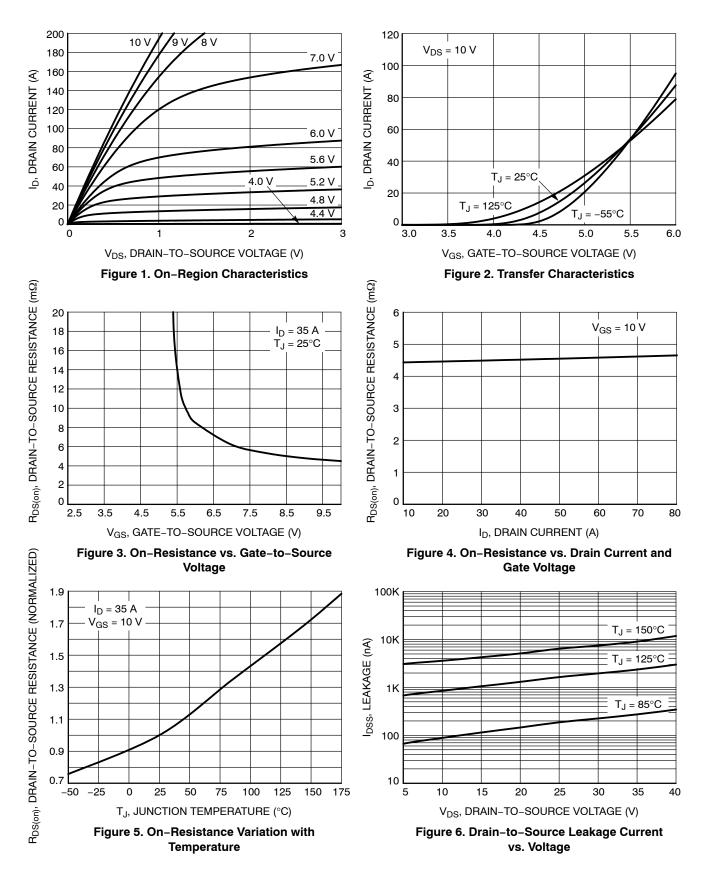
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
$\begin{array}{ c c c c c c } \hline Drain-to-Source Breakdown Voltage Temperature Coefficient $V_{IBRJDSS}'_{IJ}$ & $V_{ISB} = 0 V, $V_{IS} = 0$	OFF CHARACTERISTICS							•
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		40			V
$ \begin{array}{ c c c c c } \hline V_{DS} = 40 \ V & \hline T_{J} = 125^{\circ} C & I & 250 \\ \hline T_{J} = 125^{\circ} C & I & 250 \\ \hline T_{J} = 125^{\circ} C & I & 100 & nA \\ \hline \\ $						22		mV/°C
$ \begin{array}{ c c c c } \hline T_{1} = 125^{\circ} C & 250 \\ T_{1} = 125^{\circ} C & 100 \\ \hline 100 & nA \\ \hline 0N CHARACTERISTICS (Note 4) \\ \hline ON CHARACTERISTICS (Note 4) \\ \hline OA CHARACTERISTICS (Note 4) \\ \hline Cate Threshold Voltage & V_{GS}(TH) \\ \hline V_{GS} = V_{DS}, I_{D} = 40 \ \mu A & 2.5 & 3.5 \\ \hline V_{Threshold Temperature Coefficient & V_{GS}(TH)_{TJ} \\ \hline Threshold Temperature Coefficient & V_{GS}(TH)_{TJ} \\ \hline Threshold Temperature Coefficient & V_{GS}(TH)_{TJ} \\ \hline Threshold Temperature Coefficient & V_{GS}(TH)_{TJ} \\ \hline Drain-to-Source On Resistance & R_{DS}(n) \\ \hline V_{GS} = 10 \ V & I_{D} = 35 \ A & 4.4 & 5.3 \\ \hline Tore Aracteristic S (APACITANCES & GATE RESISTANCE \\ \hline Input Capacitance & C_{GS} \\ \hline Output Capacitance & C_{GS} \\ \hline Output Capacitance & C_{GS} \\ \hline Total Gate Charge & Q_{G}(TH) \\ \hline Threshold Gate Charge & Q_{GG} \\ \hline Cate to-Source Charge & Q_{GG} \\ \hline Reverse Transfer Capacitance & C_{GS} \\ \hline Cate to-Source Charge & Q_{GG} \\ \hline Cate to-Source Charge & Q_{GG} \\ \hline Cate to-Source Charge & Q_{GG} \\ \hline Plateau Voltage & V_{GP} \\ \hline Turn-On Delay Time & t_{d}(OFF) \\ \hline Turn-On Delay Time & t_{d}(OFF) \\ \hline Turn-On Delay Time & t_{d}(OFF) \\ \hline Fail Time & t_{T} \\ \hline Turn-Off Delay Time & t_{d}(OFF) \\ \hline Fail Time & t_{T} \\ \hline Drain-Source Diode CHARACTERISTICS \\ \hline Forward Diode Voltage & V_{SD} \\ \hline Proverd Diode Voltage & t_{RR} \\ \hline Charge Time & t_{h} \\ \hline Discharge Time & t_{h$	Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V, T_{J} = 25 °C$	T _J = 25 °C			10	
		$V_{DS} = 40 V$ $T_{J} = 125'$	T _J = 125°C			250	μA	
$ \begin{array}{ c c c c c } \hline Gate Threshold Voltage & V_{GS}(TH) & V_{GS} = V_{DS}, I_D = 40 \ \mu A & 2.5 & 3.5 & V \\ \hline Threshold Temperature Coefficient & V_{GS}(TH) / T_J & -8.0 & mV/^{C} \\ \hline Threshold Temperature Coefficient & V_{GS}(TH) / T_J & I_D = 35 \ A & 4.4 & 5.3 & m\Omega \\ \hline Threshold Temperature Coefficient & Q_{GS}(TH) & V_{GS} = 10 \ V & I_D = 35 \ A & 5.3 & 5. & MV/^{C} \\ \hline Threshold Transconductance & Q_{FS} & $V_{DS} = 15 \ V, I_D = 35 \ A & 5.3 & S \\ \hline CHARGES, CAPACITANCES & GATE RESISTANCE & 1000 & 0 \\ \hline Input Capacitance & C_{ISS} & $V_{GS} = 0 \ V, \ f = 1 \ MHz, \ V_{DS} = 25 \ V & 530 & 0 \\ \hline Cutput Capacitance & C_{RSS} & $V_{GS} = 0 \ V, \ f = 1 \ MHz, \ V_{DS} = 25 \ V & 530 & 0 \\ \hline Cate - Charge & $Q_{G}(Th) \ Threshold Gate Charge & $Q_{G}(Th) \ Threshold Gate Charge & $Q_{G}(Th) \ Threshold Gate Charge & Q_{GS} \\ \hline Cate - D-Drain Charge & $Q_{G}(Th) \ Threshold Gate Charge & Q_{GD} \\ \hline Plateau \ Votage & V_{QP} & $V_{GS} = 10 \ V, \ V_{DS} = 32 \ V; \ I_D = 35 \ A & 5.7 \ D & $0 \ V \ SWITCHING CHARACTERISTICS \ (Note 5) \\ \hline Turn-On Delay Time & $t_{d}(ON) \ Turn-On Delay Time & $t_{d}(ON) \ Turn-Of Delay Time & $t_{d}(OF)$ \\ \hline Fall Time & $t_{T} \ Turn-Off Delay Time & $t_{d}(OF)$ \\ \hline Fall Time & $t_{T} \ Suppose \ Su$	Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{G}	_S = 20 V			100	nA
$\begin{array}{ c c c c c } \hline Threshold Temperature Coefficient & V_{GS(TH)}/T_J & & & & & & & & & & & & & & & & & & &$	ON CHARACTERISTICS (Note 4)							
$ \begin{array}{ c c c } \hline \mbox{Drain-to-Source On Resistance} & \mbox{R}_{DS(on)} & \mbox{V}_{GS} = 10 \ V & \mbox{I}_{D} = 35 \ A & \mbox{I}_{A} & \mbox{5.3} & \mbox{M} & \mbox{S} \\ \hline \mbox{Forward Transconductance} & \mbox{g}_{FS} & \mbox{V}_{DS} = 15 \ V, \ \mbox{I}_{D} = 35 \ A & \mbox{S} & \mbox{S} & \mbox{S} \\ \hline \mbox{CHARGES, CAPACITANCES & GATE RESISTANCE} & \mbox{V}_{DS} = 15 \ V, \ \mbox{I}_{D} = 35 \ A & \mbox{S} & \mbox{S} & \mbox{S} & \mbox{S} \\ \hline \mbox{ChargeActance} & \mbox{C}(SS) & \mbox{V}_{QS} = 0 \ V, \ \mbox{f} = 1 \ \mbox{MH}_{Z}, \ \mbox{V}_{DS} = 25 \ V & \mbox{S} & \mbox{ChargeActance} & \mbox{C}(SS) & \mbox{C} & \mbox{S} & \m$	Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{D}$	e = 40 μA	2.5		3.5	V
$ \begin{array}{ c c c c } \hline Forward Transconductance & G_{FS} & V_{DS} = 15 \ V, \ I_{D} = 35 \ A & 53 & S \\ \hline \mbox{CHARGES, CAPACITANCES & GATE RESISTANCE} \\ \hline \mbox{Input Capacitance} & C_{ISS} & & V_{GS} = 0 \ V, \ f = 1 \ MHz, \ V_{DS} = 25 \ V & 530 & M \\ \hline \mbox{Cuput Capacitance} & C_{RSS} & & V_{GS} = 0 \ V, \ f = 1 \ MHz, \ V_{DS} = 25 \ V & 530 & M \\ \hline \mbox{Cata charge} & C_{RSS} & & & & & & & & & & & & & & & & & & $	Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-8.0		mV/°C
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 35 A		4.4	5.3	mΩ
$\begin{array}{ c c c c c c } \hline Input Capacitance & C_{ISS} \\ \hline Output Capacitance & C_{OSS} \\ \hline Output Capacitance & C_{OSS} \\ \hline Reverse Transfer Capacitance & C_{RSS} \\ \hline Total Gate Charge & Q_{G(TOT)} \\ \hline Threshold Gate Charge & Q_{GS} \\ \hline Gate-to-Source Charge & Q_{GS} \\ \hline Gate-to-Drain Charge & Q_{GD} \\ \hline Plateau Voltage & V_{GP} \\ \hline \\ \hline Subtree & V_{GS} = 10 V, V_{DS} = 32 V; I_D = 35 A \\ \hline \\ Subtree & Subtr$	Forward Transconductance	9 _{FS}	V _{DS} =15 V, I _D = 35 A			53		S
$ \begin{array}{ c c c c c } \hline Output Capacitance & C_{OSS} \\ \hline PF \\ \hline Reverse Transfer Capacitance & C_{RSS} \\ \hline Total Gate Charge & Q_{G(TOT)} \\ \hline Threshold Gate Charge & Q_{G(TH)} \\ \hline Gate-to-Source Charge & Q_{GS} \\ \hline Gate-to-Drain Charge & Q_{GD} \\ \hline Plateau Voltage & V_{GP} \\ \hline \\ \hline SWITCHING CHARACTERISTICS (Note 5) \\ \hline \\ \hline Turn-On Delay Time & t_{d(ON)} \\ \hline Rise Time & t_{f} \\ \hline \\ Fall Time & t_{f} \\ \hline \\ Fall Time & t_{f} \\ \hline \\ \hline \\ Fall Time & t_{f} \\ \hline \\ $	CHARGES, CAPACITANCES & GATE RE	SISTANCE			-			
$ \begin{array}{ c c c c c } \hline Reverse Transfer Capacitance & C_{RSS} & & & & & & & & & & & & & & & & & & $	Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			1000		pF
$ \begin{array}{ c c c c } \hline Total Gate Charge & $Q_{G}(TOT)$ \\ \hline Threshold Gate Charge & $Q_{G}(TH)$ \\ \hline Gate-to-Source Charge & Q_{GB} \\ \hline Gate-to-Drain Charge & Q_{GD} \\ \hline Plateau Voltage & V_{GP} \\ \hline \\ $	Output Capacitance	C _{OSS}				530		
$ \begin{array}{ c c c c c } \hline Threshold Gate Charge & Q_{G(TH)} \\ \hline Gate-to-Source Charge & Q_{GS} \\ \hline Gate-to-Drain Charge & Q_{GD} \\ \hline Plateau Voltage & V_{GP} \\ \hline \\ \hline Plateau Voltage & V_{GP} \\ \hline \\ $	Reverse Transfer Capacitance	C _{RSS}				22		
$ \begin{array}{ c c c c c } \hline Gate-to-Source Charge & Q_{GS} \\ \hline Gate-to-Drain Charge & Q_{GD} \\ \hline Plateau Voltage & V_{GP} \\ \hline \\ $	Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 32 V; I _D = 35 A			16		nC
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Threshold Gate Charge	Q _{G(TH)}				3.2		
$ \begin{array}{c c c c c c c c c } \hline Plateau Voltage & V_{GP} & & & & & & & & & & & & & & & & & & &$	Gate-to-Source Charge	Q _{GS}				5.7		
$\begin{tabular}{ c c c c c c } \hline Turn-On Delay Time & t_{d(ON)} \\ \hline Turn-On Delay Time & t_r \\ \hline Turn-Off Delay Time & t_d(OFF) \\ \hline Fall Time & t_f \\ \hline Tall Time & t_f \\ \hline Turn-Off Delay Time & t_d(OFF) \\ \hline Fall Time & t_f \\ \hline DRAIN-SOURCE DIODE CHARACTERISTICS \\ \hline Forward Diode Voltage & V_{SD} & V_{GS} = 0 V, \\ \hline I_S = 35 A, \\ \hline$	Gate-to-Drain Charge	Q _{GD}				2.7		
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Plateau Voltage	V _{GP}				5.2		V
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	SWITCHING CHARACTERISTICS (Note 5	5)						•
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Turn-On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DS} = 32 V, I_{D} = 35 A, R_{G} = 1 Ω			11		
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Rise Time	tr				72		ns
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Turn-Off Delay Time	t _{d(OFF)}				24		
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Fall Time	t _f				8.0		
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	DRAIN-SOURCE DIODE CHARACTERIS	TICS				-		•
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	Forward Diode Voltage	V _{SD}	V_{SD} $V_{CS} = 0 V.$	$T_J = 25^{\circ}C$		0.87	1.2	
Charge Time t_a $V_{GS} = 0 V$, $dIs/dt = 100 A/\mu s$,17nsDischarge Time t_b $I_S = 35 A$ 18		I _S = 35 A	T _J = 125°C		0.75			
Discharge Time t_b $I_S = 35 \text{ A}$ 18	Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dls/dt = 100 A/µs, I _S = 35 A			36		ns
Discharge Time t _b I _S = 35 A 18	Charge Time	ta				17		
Reverse Recovery Charge Q _{RR} 16 nC	Discharge Time	t _b				18		
	Reverse Recovery Charge	Q _{RR}				16		nC

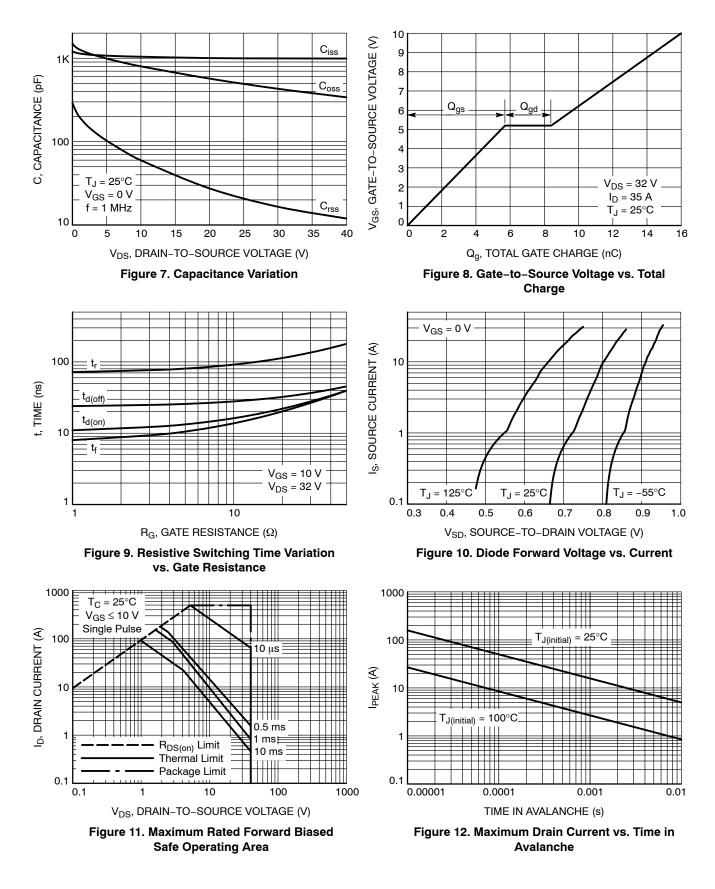
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

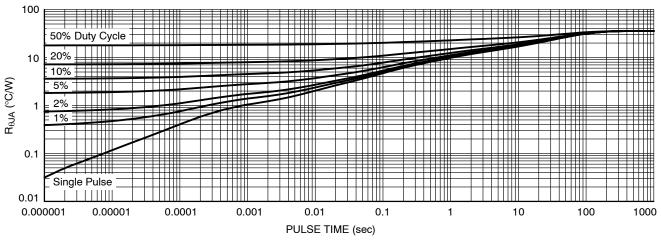


Figure 13. Thermal Characteristics

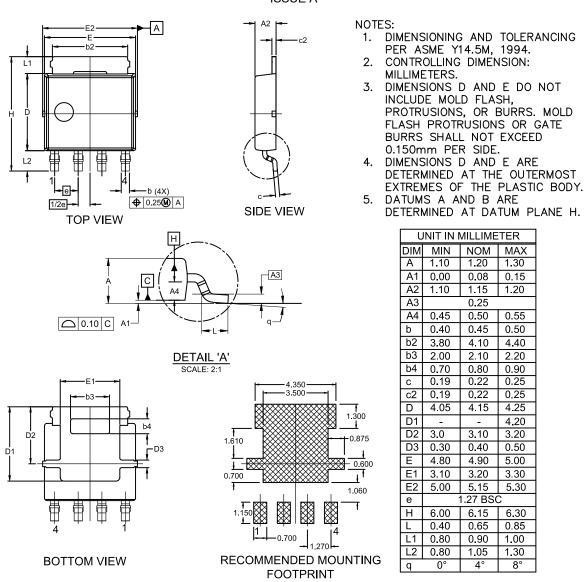
DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMYS5D3N04CTWG	5D3N04C	LFPAK4 (Pb–Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

LFPAK4 5x6 CASE 760AB ISSUE A



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